

### FAST RECOVERY RECTIFIER

VOLTAGE RANGE: 100--- 1000 V  
CURRENT: 3.0 A

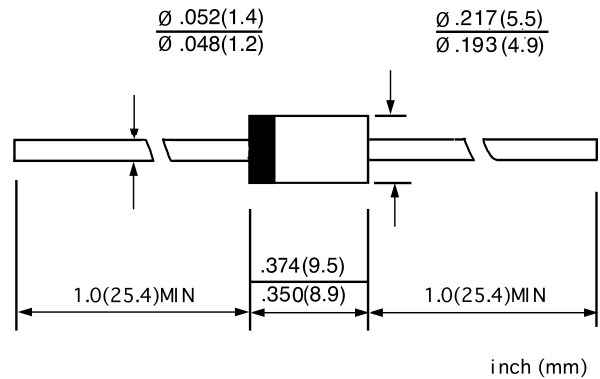
#### FEATURES

- ◇ Low cost
- ◇ Diffused junction
- ◇ Low leakage
- ◇ Low forward voltage drop
- ◇ High current capability
- ◇ Easily cleaned with Freon,Alcohol,Isopropanol and similar solvents
- ◇ The plastic material carries U/L recognition 94V-0

#### MECHANICAL DATA

- ◇ Case:JEDEC DO-27,molded plastic
- ◇ Terminals: Axial lead ,solderable per MIL- STD-202,Method 208
- ◇ Polarity: Color band denotes cathode
- ◇ Weight:0.041 ounces,1.15 grams
- ◇ Mounting position: Any

#### DO - 27



#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase,half wave,60 Hz,resistive or inductive load. For capacitive load,derate by 20%.

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Maximum recurrent peak reverse voltage	$V_{RRM}$	100	200	400	800	1000	V
Maximum RMS voltage	$V_{RMS}$	70	140	280	560	700	V
Maximum DC blocking voltage	$V_{DC}$	100	200	400	800	1000	V
Maximum average forward rectified current 9.5mm lead length, @ $T_A=75^\circ C$	$I_{F(AV)}$	3.0					A
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load @ $T_J=125^\circ C$	$I_{FSM}$	100.0					A
Maximum instantaneous forward voltage @ 3.0 A	$V_F$	1.25					V
Maximum reverse current @ $T_A=25^\circ C$ at rated DC blocking voltage @ $T_A=100^\circ C$	$I_R$	10.0 200.0					$\mu A$
Maximum reverse recovery time (Note1)	$t_{rr}$	150					ns
Typical junction capacitance (Note2)	$C_J$	32					pF
Typical thermal resistance (Note3)	$R_{\theta JA}$	22					$^\circ C/W$
Operating junction temperature range	$T_J$	- 55---- +150					$^\circ C$
Storage temperature range	$T_{STG}$	- 55---- +150					$^\circ C$

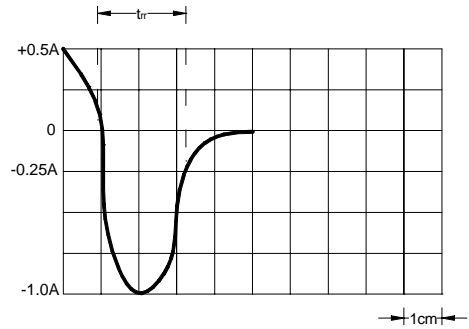
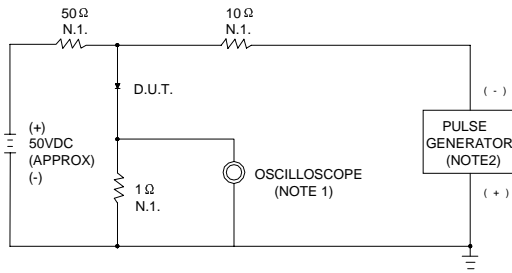
NOTE:1. Measured with  $I_F=0.5A$ ,  $I_R=1A$ ,  $I_{rr}=0.25A$ .

2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

3. Thermal resistance from junction to ambient.

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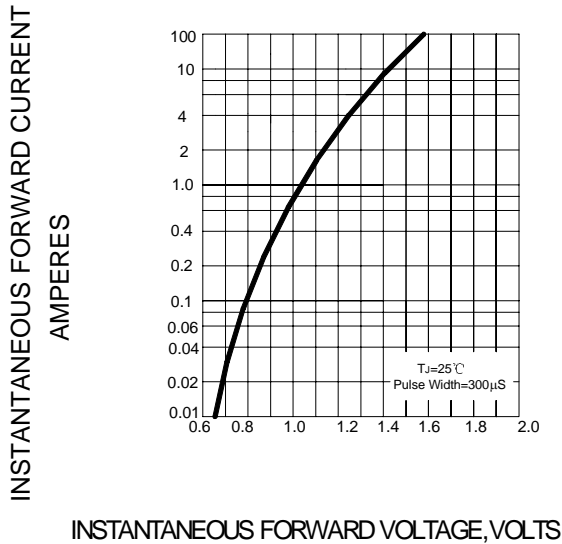
**FIG.1 – REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM**



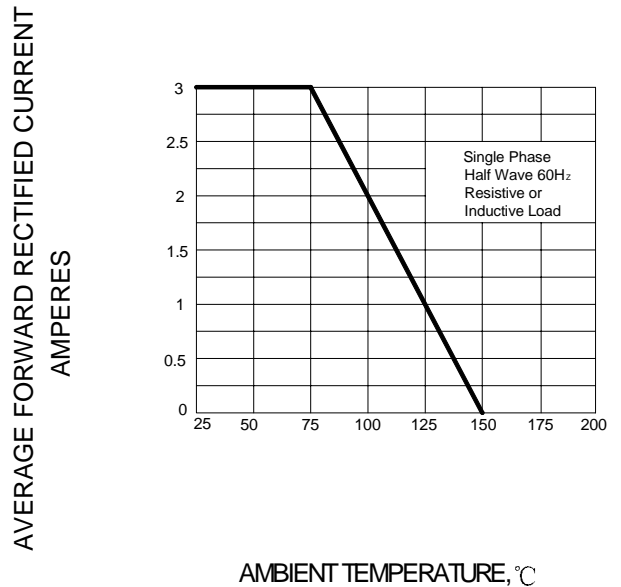
NOTES:1.RISE TIME=7ns MAX. INPUT IMPEDANCE=1MΩ.22pF  
2.RISE TIME=10ns MAX. SOURCE IMPEDANCE=50Ω

SET TIME BASE FOR 50/100 ns /cm

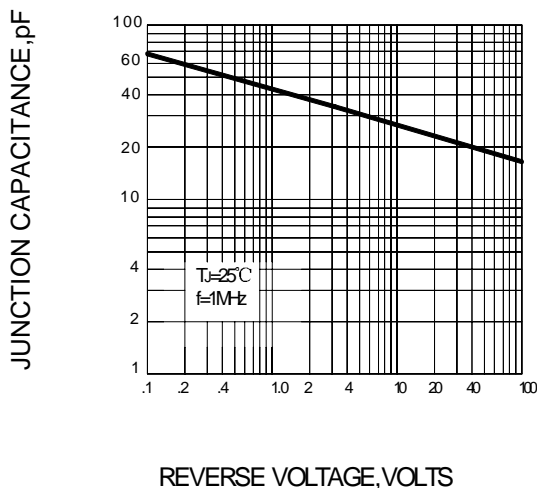
**FIG.2 – TYPICAL FORWARD CHARACTERISTIC**



**FIG.3 – FORWARD DERATING CURVE**



**FIG.4 – TYPICAL JUNCTION CAPACITANCE**



**FIG.5 – PEAK FORWARD SURGE CURRENT**

